Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSVII)

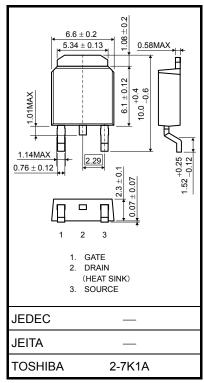
TK5P53D

Switching Regulator Applications

- Low drain-source ON-resistance: RDS (ON) = 1.2 Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 2.8 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 525 \ V)$
- Enhancement-mode: $V_{th} = 2.4$ to 4.4 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	525	V
Gate-source voltage		V _{GSS}	±30	V
Drain current	DC (Note 1)	۱ _D	5	
	Pulse (t = 1 ms) (Note 1)	I _{DP}	20	A
Drain power dissipati	on (Tc = 25°C)	PD	80	W
Single pulse avalanche energy (Note 2)		E _{AS}	142	mJ
Avalanche current (Note 3)		I _{AR}	5	А
Repetitive avalanche energy		E _{AR}	8.0	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature range		T _{stg}	-55 to 150	°C



Weight : 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

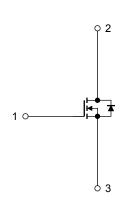
Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.56	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 9.72 mH, $R_G = 25 \Omega$, $I_{AR} = 5 \text{ A}$ Note 3: Repetitive rating: pulse width limited by maximum channel temperature This transistor is an electrostatic sensitive device. Please handle with caution.

Note 1: Please use devices on conditions that the channel temperature is below 150°C.

Internal Connection



1

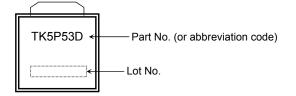
Electrical Characteristics (Ta = 25°C)

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS}=\pm 30~V,~V_{DS}=0~V$	_		±1	μA
Drain cut-off current		IDSS	$V_{DS} = 525 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	525			V
Gate threshold v	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.4		4.4	V
Drain-source ON	I-resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	_	1.2	1.5	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	0.7	2.8	—	S
Input capacitance		C _{iss}		_	540	—	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	3	—	pF
Output capacitance		C _{oss}	1	_	60	_	
Switching time	Rise time	t _r	$\begin{array}{c} 10 \text{ V} \\ \text{V}_{GS} \\ 0 \text{ V} \\ 50 \Omega \\ \end{array} \\ \begin{array}{c} \text{I}_{D} = 2.5 \text{ A} \\ \text{V}_{OUT} \\ \text{O} \\ \text{V}_{DD} \\ \end{array} \\ \begin{array}{c} \text{R}_{L} = \\ 80 \Omega \\ \\ \text{V}_{DD} \approx 200 \text{ V} \\ \end{array} \\ \begin{array}{c} \text{Duty} \leq 1\%, t_{W} = 10 \ \mu\text{s} \end{array}$	_	18		
	Turn-on time	t _{on}			40		ns
	Fall time	t _f			8	_	. 115
	Turn-off time	t _{off}			55	—	
Total gate charge		Qg		_	11	—	
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	_	6	—	nC
Gate-drain charge		Q _{gd}]	_	5	—	

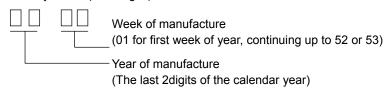
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	5	А
Pulse drain reverse current (Note 1)	I _{DRP}	—			20	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 5 \text{ A}, V_{GS} = 0 \text{ V},$	_	1000	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs	_	6	_	μC

Marking



Note 4: * Weekly code: (Four digits)



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0.1⊾ 0.1

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Drain current ID (A)

1

100

7

6.5

6

50

VGS 5.5V

40

(V)

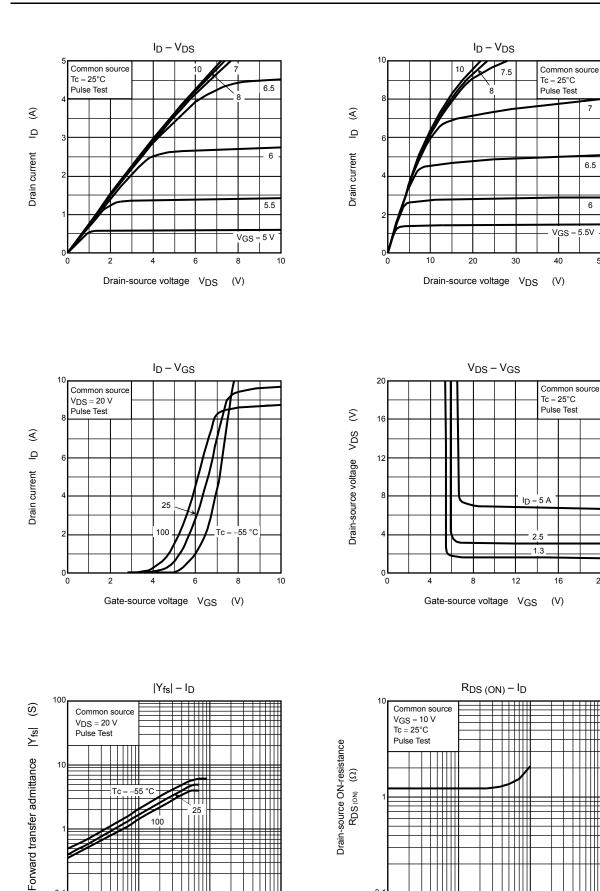
16

(V)

10

Drain current ID (A)

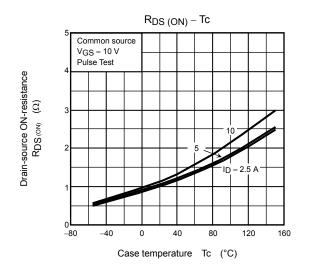
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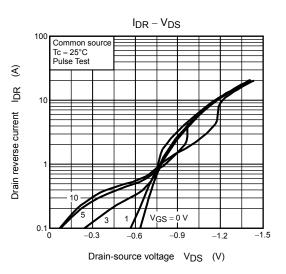


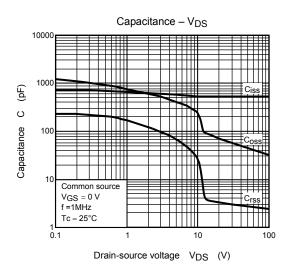
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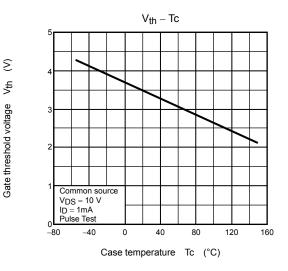
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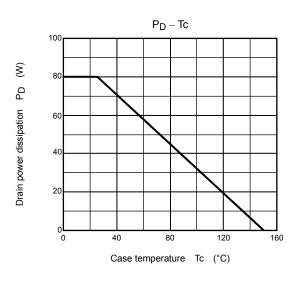
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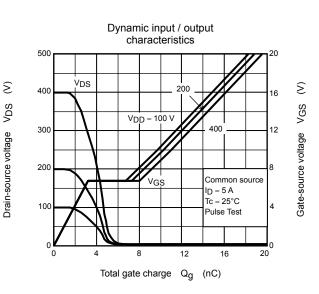


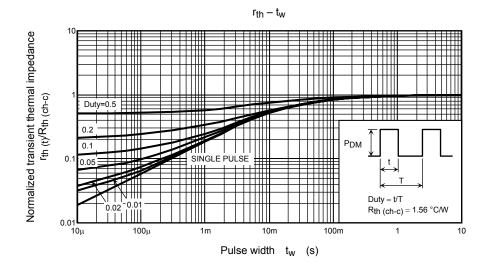




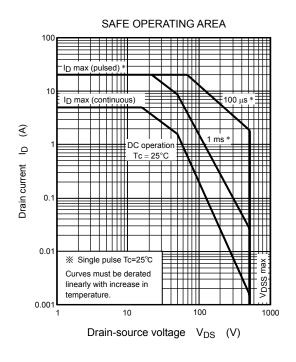


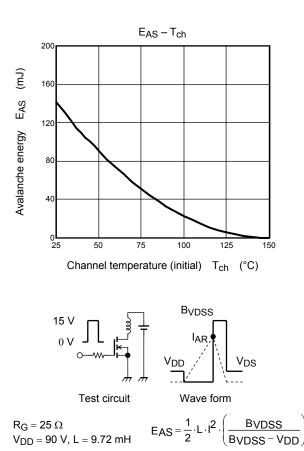






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